

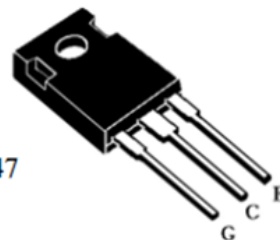
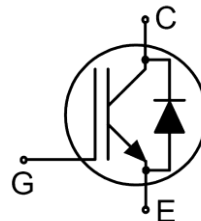


TT025N120FQ

主要参数 MAIN CHARACTERISTICS

I _c	25 A
V _{CEs}	1200V
V _{cesat-typ} (V _{ge} =15V)	1.6V

封装 Package



TO-247

用途

- 逆变器

APPLICATIONS

- General purpose inverter

产品特性

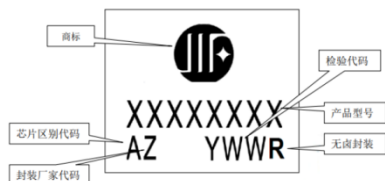
- 低栅极电荷
- Trench FS 技术
- RoHS 产品

FEATURES

- Low gate charge
- Trench FS Technology
- RoHS product

印记定义

Mark definition



TO-247 印章定义:

产品型号说明(具体位数由产品决定): 产品类型+工艺平台+电流+频率+电压+工艺版本+特殊特性。

检验代码说明: Y(年代码, 执行内部定义)+WW (周代码)

订货信息 ORDER MESSAGE

订货型号 Order codes	印记 Marking	封装 Package
无卤-条管 Halogen-Free-Tube		
TT025N120FQ-GE-BR	TT025N120FQ	TO-247

绝对最大额定值 ABSOLUTE RATINGS ($T_C=25^\circ\text{C}$)

项 目 Parameter	符 号 Symbol	数 值 Value	单 位 Unit
最高集电极-发射极直流电压 Collector-Emitter Voltage	V_{CE}	1200	V
*连续集电极电流 Collector Current-continuous	I_C	50($T_C=25^\circ\text{C}$)	A
		25($T_C=100^\circ\text{C}$)	
最大脉冲集电极极电流 (注1) Collector Current – pulse (note 1)	I_{CM}	75	
二极管正向电流 Diode RMS forward current	I_F	50($T_C=25^\circ\text{C}$)	
		25($T_C=100^\circ\text{C}$)	
二极管正向不重复峰值电流 (浪涌电流) Surge non repetitive forward current $t_p=10\text{ ms}$ sinusoidal	I_{FSM}	75	
栅极发射极电压 Gate-Emitter Voltage	V_{GE}	± 20	V
安全工作区 Turn-off safe area	-	75	A
耗散功率 Power Dissipation	P_D $T_C=25^\circ\text{C}$	272.7	W
存储温度 Storage Temperature Range	T_{STG}	$-55\sim+150$	$^\circ\text{C}$
结温 Junction Temperature Range	T_{vj}	$-55\sim+175$	
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	T_L	300	

*连续集电极电流由最高结温限制

*Collector current limited by maximum junction temperature

注释:

1: 脉冲宽度由最高结温限制

Notes:

1: Pulse width limited by maximum junction temperature



电特性 ELECTRICAL CHARACTERISTICS

项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
关态特性 Off –Characteristics						
集电极-发射极击穿电压 Collector-Emitter Voltage	BV_{CES}	$I_C=250\mu A, V_{GE}=0V$	1200	-	-	V
零栅压下集电极漏电流 Zero Gate Voltage Collector Current	I_{CES}	$V_{CE}=1200V, V_{GE}=0V, T_C=25^\circ C$	-	-	0.2	mA
		$V_{CE}=1200V, V_{GE}=0V, T_C=175^\circ C$	-	2	-	
正向栅极体漏电流 Gate-body leakage current, forward	I_{GESF}	$V_{CE}=0V, V_{GE}=20V$	-	-	200	nA
反向栅极体漏电流 Gate-body leakage current, reverse	I_{GESR}	$V_{CE}=0V, V_{GE}=-20V$	-	-	-200	
通态特性 On-Characteristics						
阈值电压 Gate Threshold Voltage	V_{TH}	$V_{CE} = V_{GE}, I_C=250\mu A$	4.5	5.5	6.5	V
饱和压降 Collector-Emitter saturation Voltage	V_{CESAT}	$V_{GE}=15V, I_C=25A, T_C=25^\circ C$	-	1.6	2.3	
		$V_{GE}=15V, I_C=25A, T_C=175^\circ C$	-	2.1	-	
动态特性 Dynamic Characteristics						
输入电容 Input capacitance	C_{ies}	$V_{CE}=25V, V_{GE}=0V, f=1.0MHz$	-	3118	-	pF
输出电容 Output capacitance	C_{oes}		-	99	-	
反向传输电容 Reverse transfer capacitance	C_{res}		-	33	-	
栅极电荷总量 Total Gate Charge	Q_g	$V_{CC}=960V, I_C=40A, V_{GE}=15V, T_C=25^\circ C$	-	184	-	nC
栅极-发射极电荷 Gate to emitter charge	Q_{ge}		-	19	-	
栅极-集电极电荷 Gate to collector charge	Q_{gc}		-	117	-	
栅极电阻-Gate resistance	R_g	$f=1MHz, \text{open collector}$	-	6	-	Ω
短路电流-short current	I_{sc}	$V_{GE}=15V, V_{CE}=600V, t_{sc} \leq 5\mu s$	-	140	-	A

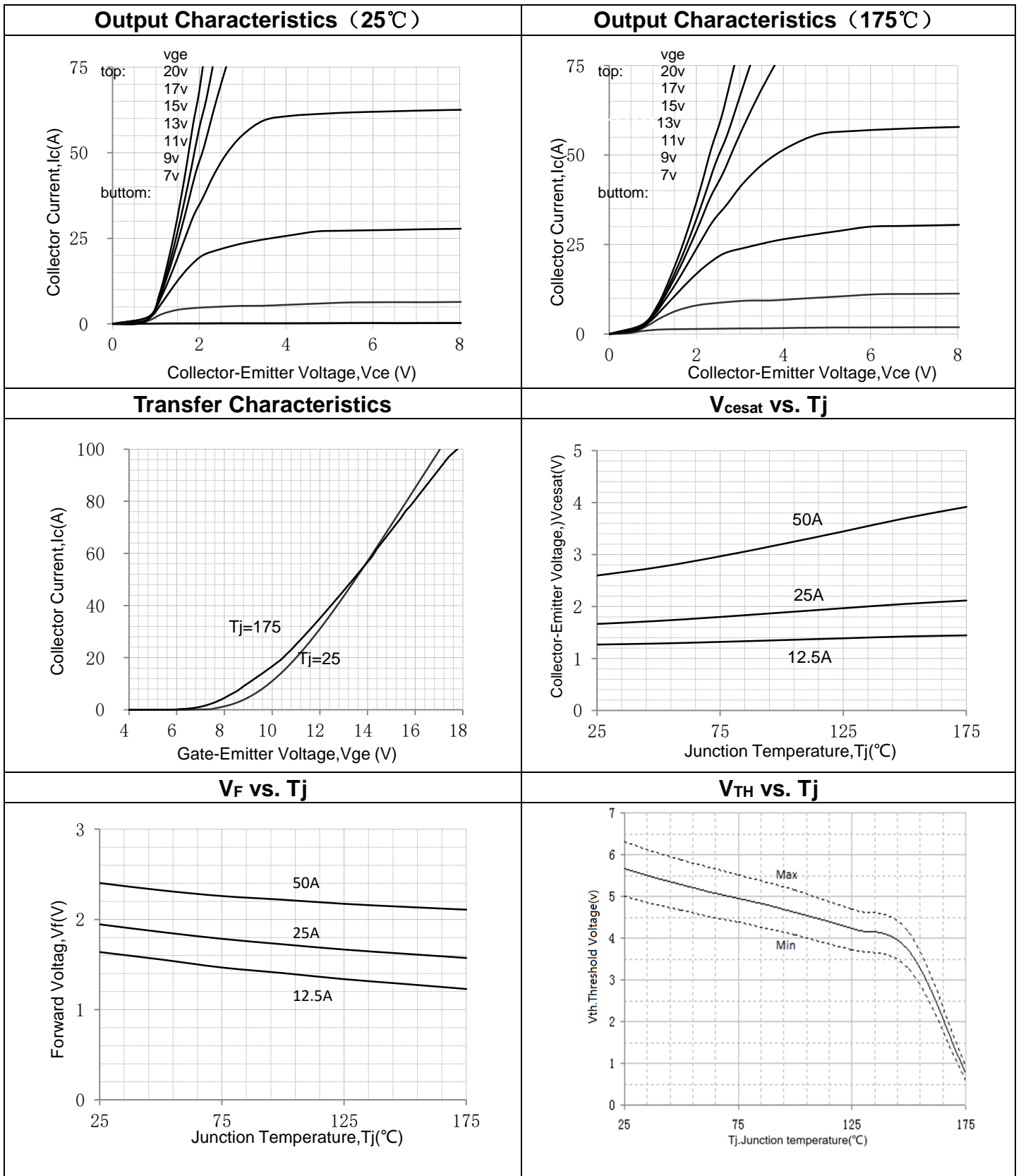


开关特性 Switching Characteristics							
项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units	
开启延迟时间 Turn-on delay time	$t_d(\text{on})$	$V_{CC}=600V, I_c=25A, R_G=10\Omega$ $V_{GE}=15V, T_C=25^\circ C$	-	30	-	ns	
上升时间 Turn-on rise time	t_r		-	44	-		
关断延迟时间 Turn-off delay time	$t_d(\text{off})$		-	264	-		
下降时间 Turn-off Fall time	t_f			-	338	-	mJ
开通损耗 Turn-on energy	E_{on}			-	0.7	-	
关断损耗 Turn-off energy	E_{off}			-	2.27	-	
总开关损耗 Total switching energy	E_{tot}			-	2.97	-	
开启延迟时间 Turn-on delay time	$t_d(\text{on})$	$V_{CC}=600V, I_c=25A, R_G=10\Omega$ $V_{GE}=15V, T_C=175^\circ C$	-	32	-	ns	
上升时间 Turn-on rise time	t_r		-	48	-		
关断延迟时间 Turn-off delay time	$t_d(\text{off})$		-	320	-		
下降时间 Turn-off Fall time	t_f			-	542	-	mJ
开通损耗 Turn-on energy	E_{on}			-	0.98	-	
关断损耗 Turn-off energy	E_{off}			-	3.17	-	
总开关损耗 Total switching energy	E_{tot}			-	4.15	-	
反并联二极管特性及最大额定值 Anti-Parallel Diode Characteristics and Maximum Ratings							
正向压降 Collector-Emitter Diode Forward Voltage	V_F	$V_{GE}=0V, I_f=25A, T_C=25^\circ C$	-	1.8	2.6	V	
		$V_{GE}=0V, I_f=25A, T_C=150^\circ C$	-	1.5			
反向恢复时间 Diode Reverse recovery time	t_{rr}	$I_F=25A,$	-	461	-	ns	
反向恢复电荷 Diode Reverse recovery charge	Q_{rr}	$V_R=600V, diF/dt=-200A/\mu s$ $T_j=25^\circ C$	-	1605	-	nC	
反向恢复电流 Diode Reverse recovery Current	I_{rrm}		-	6.5	-	A	
反向恢复时间 Diode Reverse recovery time	t_{rr}	$I_F=25A,$ $V_R=600V, diF/dt=-200A/\mu s$ $T_j=175^\circ C$	-	726	-	ns	
反向恢复电荷 Diode Reverse recovery charge	Q_{rr}		-	5410	-	nC	
反向恢复电流 Diode Reverse recovery Current	I_{rrm}		-	14.3	-	A	

项 目 Parameter	符 号 Symbol	典型值	最大值 MAX	单 位 Unit
结到管壳的热阻 IGBT Thermal Resistance, Junction to Case	$R_{th(j-c)}$	0.5	0.55	$^\circ C/W$
结到管壳的热阻 FRD Thermal Resistance, Junction to Case	$R_{th(j-c)}$	0.81	0.9	
结到环境的热阻 Thermal Resistance, Junction to Ambient	$R_{th(j-A)}$	31	40.0	

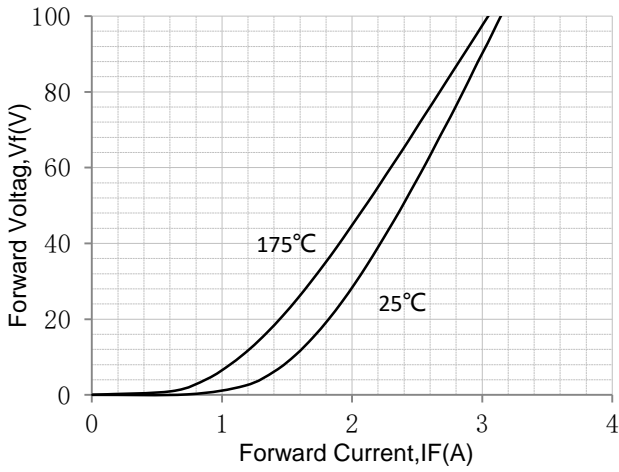


特征曲线 ELECTRICAL CHARACTERISTICS (curves)



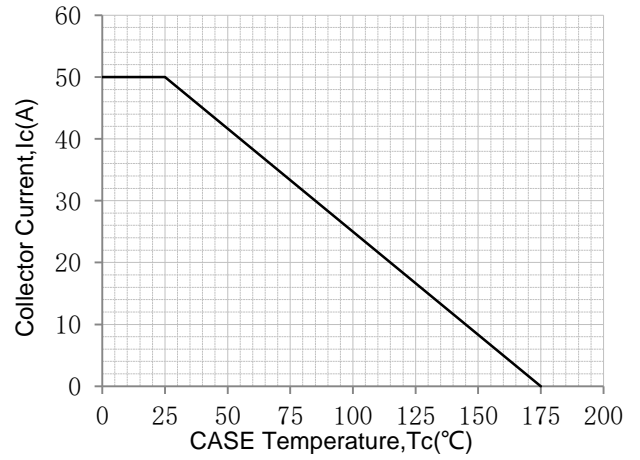


IF vs. VF



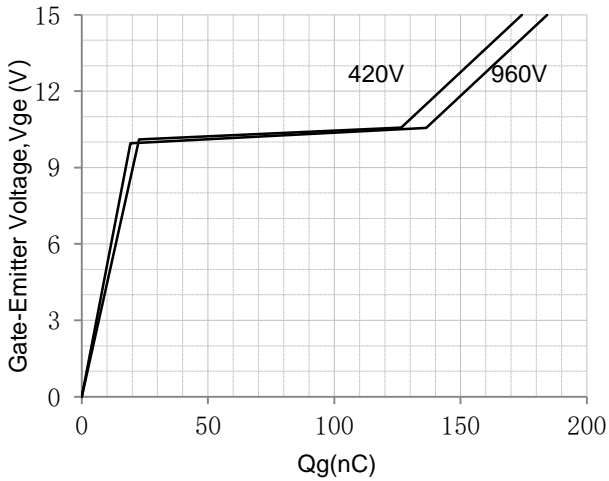
Collector current vs. case temperature

VGE ≥ 15V, Tj ≤ 175°C



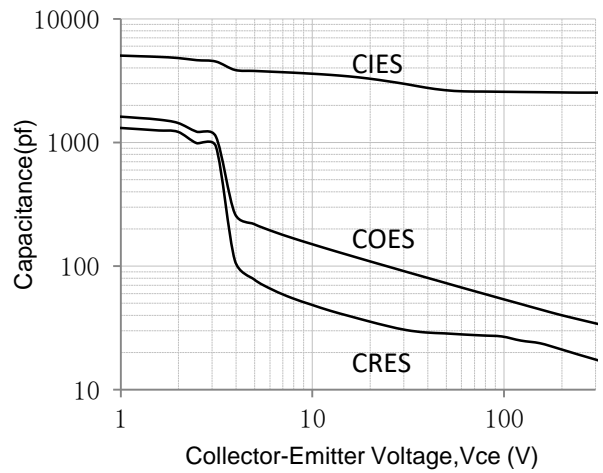
Gate Charge Characteristics

VGE = 15V, IC = 25A



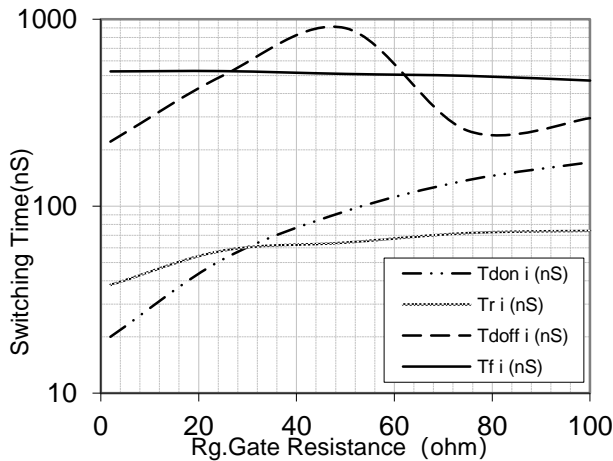
Capacitance Characteristic

VGE = 0V, f = 1.0MHz



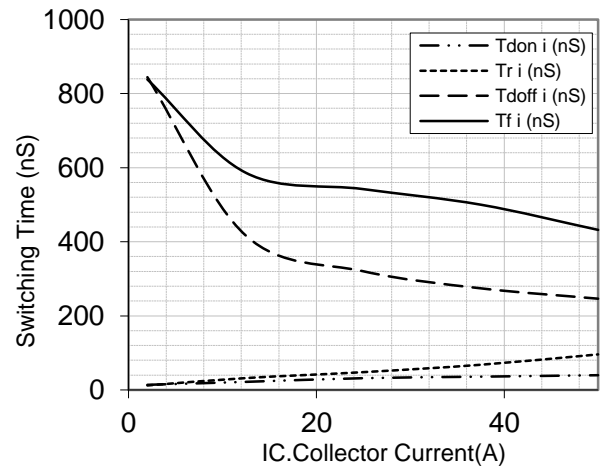
Switching Time vs. Rg (175°C)

VGE = 15V, VCE = 600V, IC = 25A



Switching Time vs. IC (175°C)

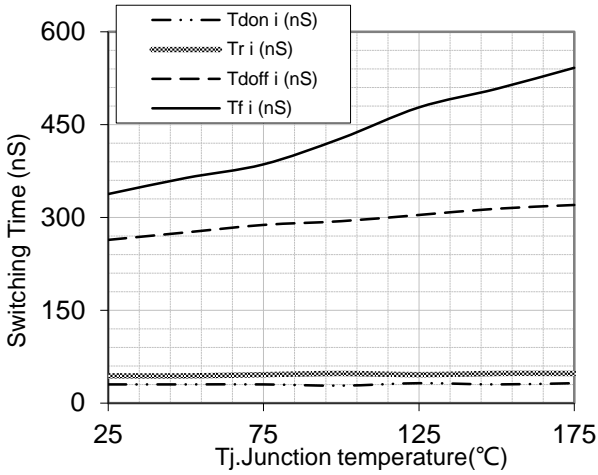
VCE = 600V, VGE = 15V, RG = 10Ω





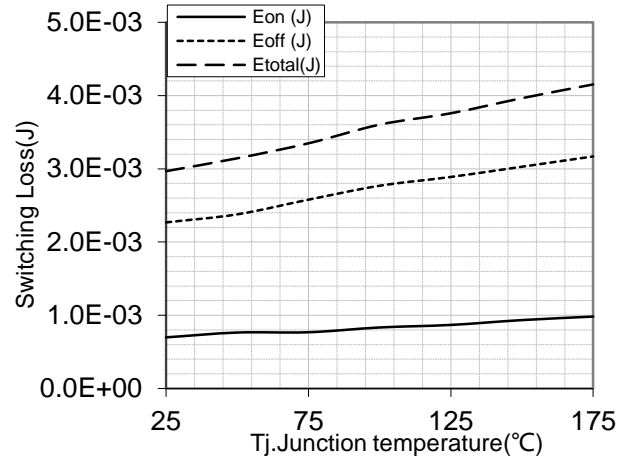
Switching Time vs.Tj

VGE=15V, VCE=600V, IC=25A, Rg=10Ω



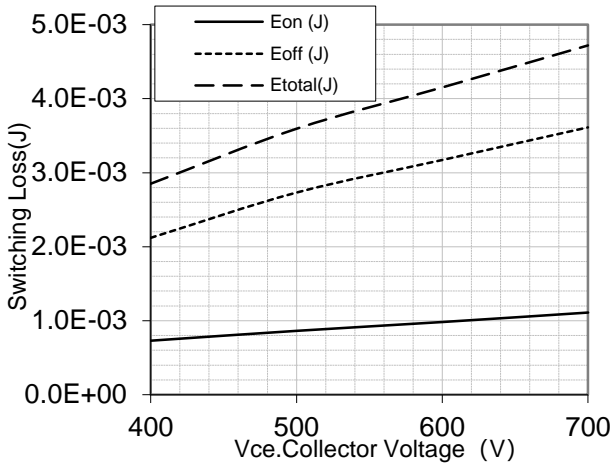
Switching Loss vs. Tj

VGE=15V, VCE=600V, IC=25A, Rg=10Ω



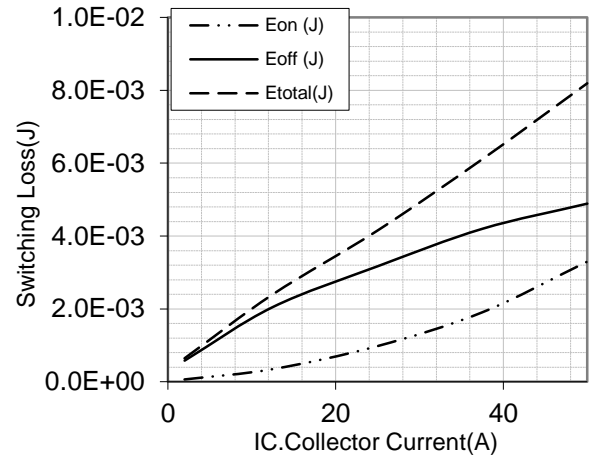
Switching Loss vs. VCE(175°C)

VGE=15V, IC=25A, Rg=10Ω



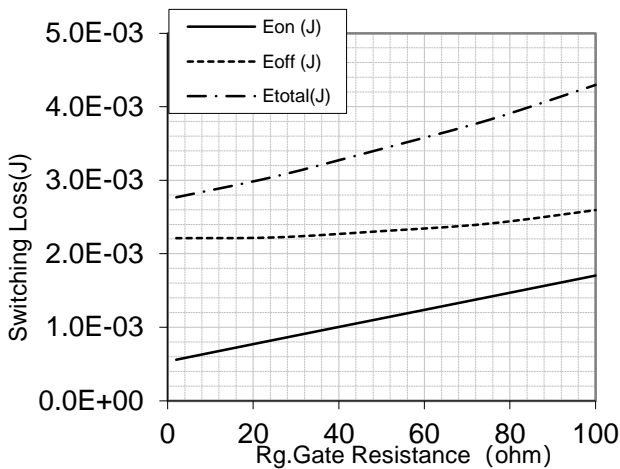
Switching Loss vs. IC(175°C)

VGE=15V, VCE=600V, Rg=10Ω



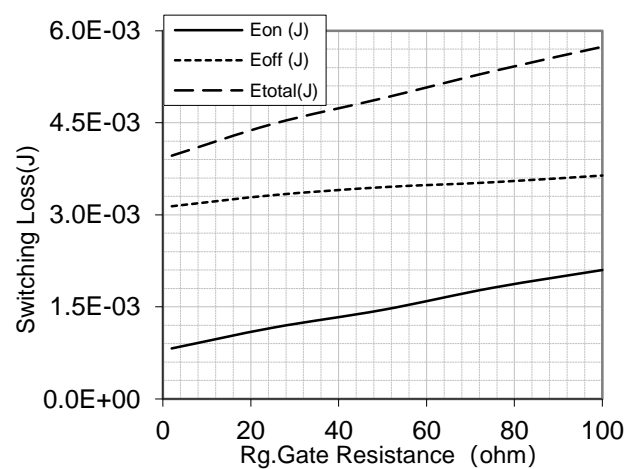
Switching Loss vs. Rg(25°C)

VGE=15V, VCE=600V, IC=25A



Switching Loss vs. Rg(175°C)

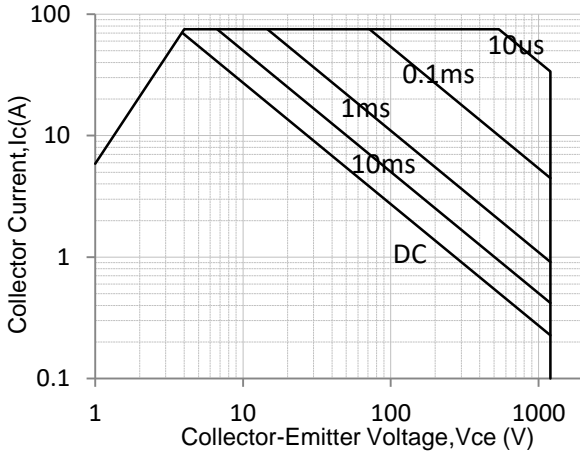
VGE=15V, VCE=600V, IC=25A





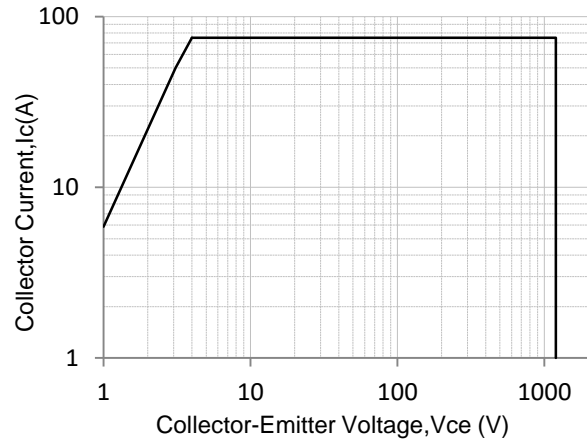
Forward Bias SOA

$T_c=25^\circ\text{C}$, $V_{GE}=15\text{V}$, $T_j \leq 175^\circ\text{C}$



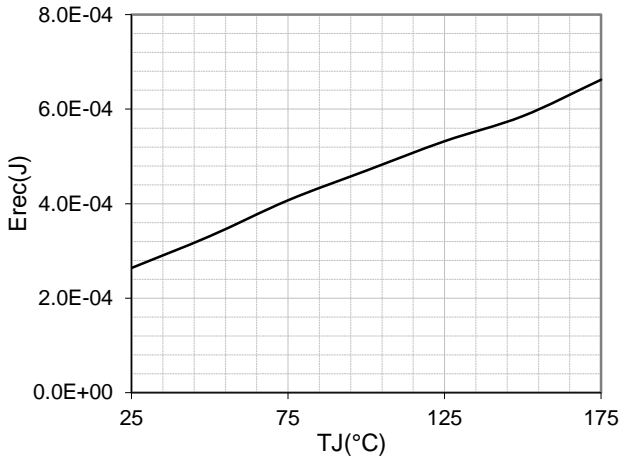
Reverse bias SOA

$V_{GE}=15\text{V}$, $T_j \leq 175^\circ\text{C}$



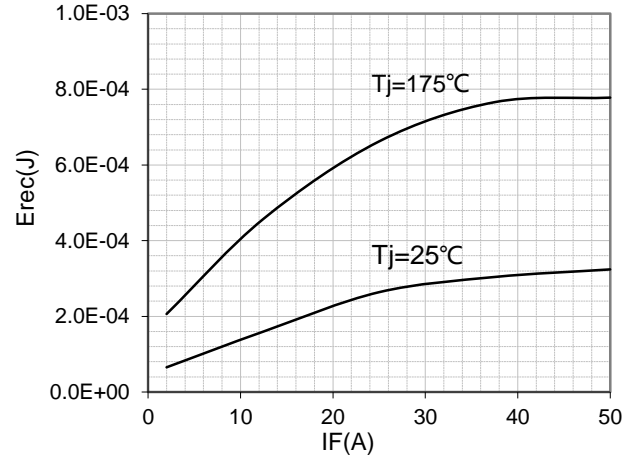
E_{rec} vs T_j

$I_f=25\text{A}$, $di/dt=200\text{A}/\mu\text{s}$, $V_{CE}=600\text{V}$, $R_g=10\Omega$



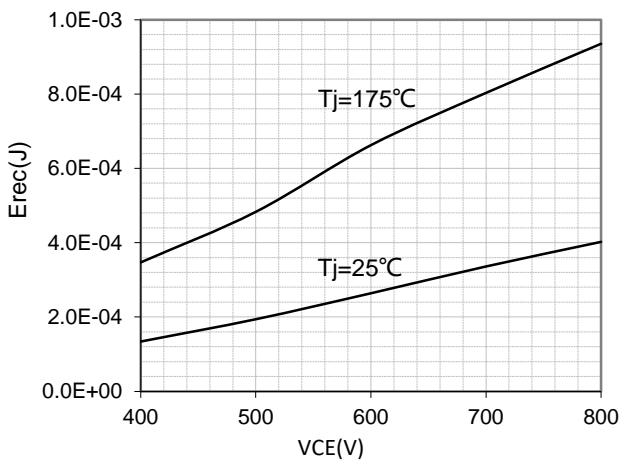
E_{rec} vs I_f

$di/dt=200\text{A}/\mu\text{s}$, $V_{CE}=600\text{V}$, $R_g=10\Omega$



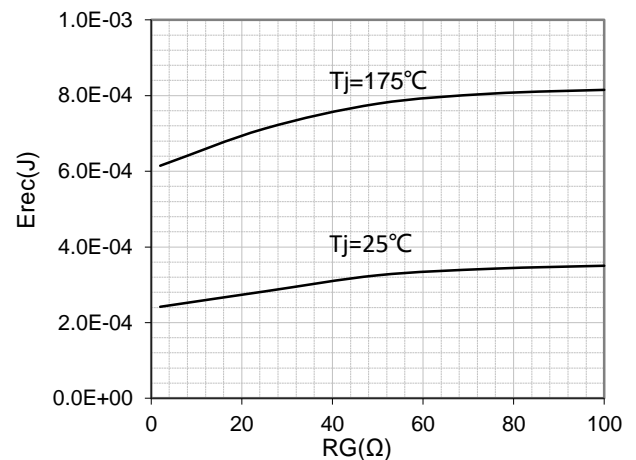
E_{rec} vs V_{CE}

$I_f=25\text{A}$, $di/dt=200\text{A}/\mu\text{s}$, $R_g=10\Omega$



E_{rec} vs R_g

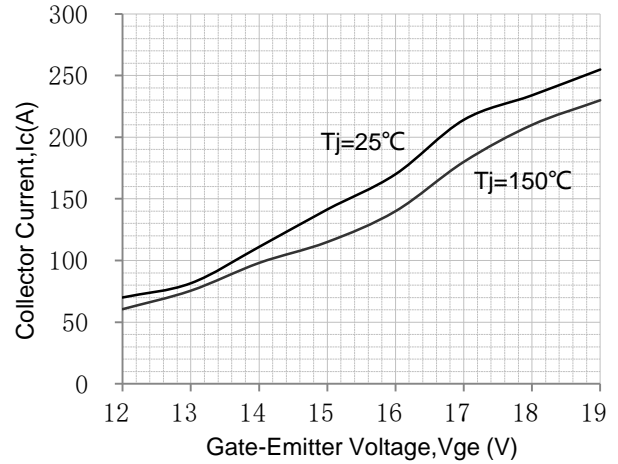
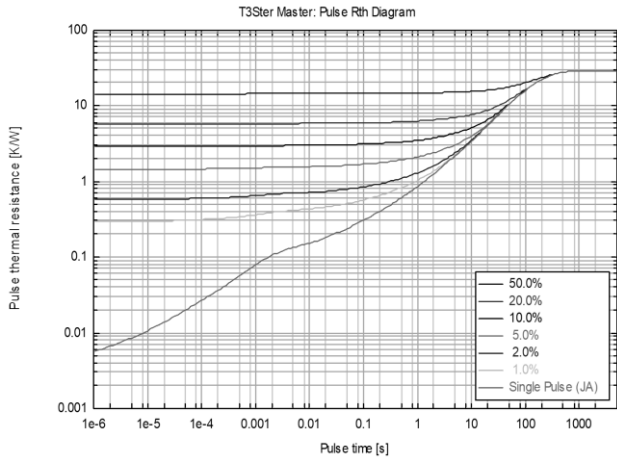
$I_f=25\text{A}$, $di/dt=200\text{A}/\mu\text{s}$, $V_{CE}=600\text{V}$



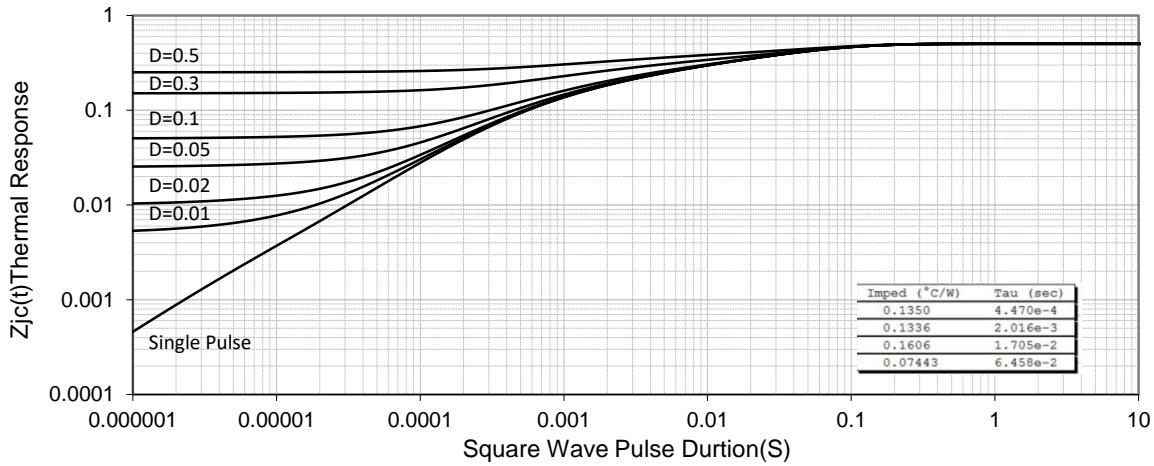


Normalized Maximum Transient Thermal Impedance for IGBT(RJA)

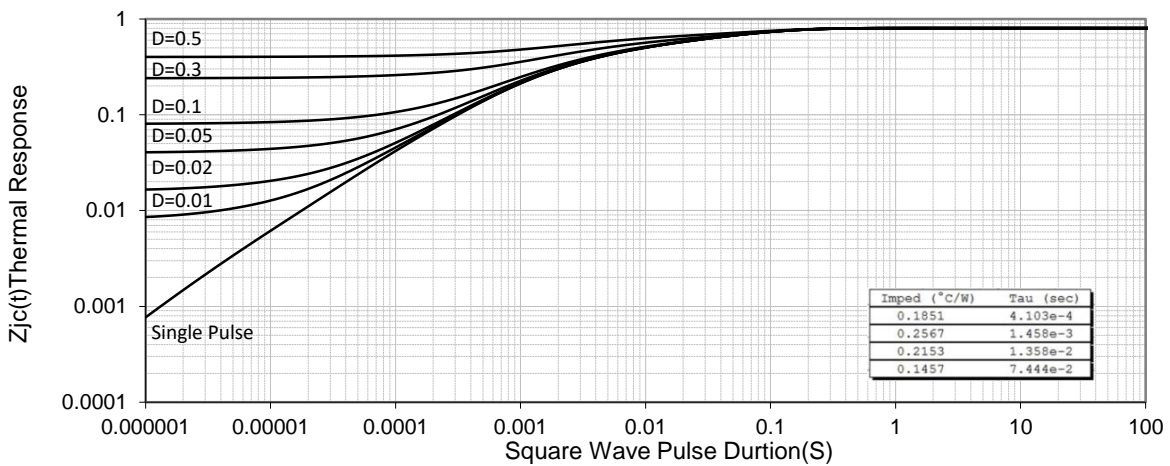
Isc vs VGE
VGE=15V, VCE=400V



Normalized Maximum Transient Thermal Impedance for IGBT(RJC)

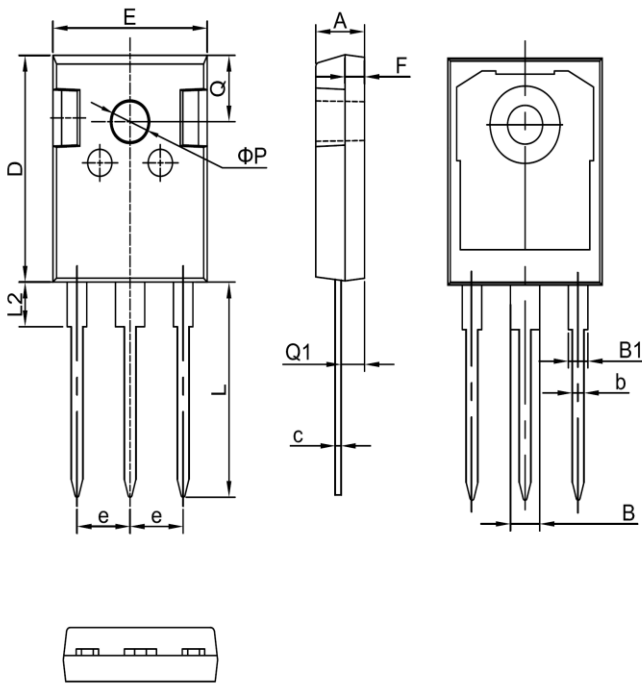


Normalized Maximum Transient Thermal Impedance for FRD(RJC)



外形尺寸 PACKAGE MECHANICAL DATA
TO-247

单位 Unit : mm



符号 symbol	MIN	MAX
A	4.90	5.10
B	2.95	3.35
B1	1.95	2.35
b	1.15	1.35
c	0.50	0.70
D	20.90	21.10
E	15.70	15.90
e	5.34	5.54
F	1.90	2.10
L	19.40	20.40
L2	4.03	4.23
Q	6.00	6.40
Q1	2.30	2.50
P	3.50	3.70

重点尺寸：b、e、A、D、E。





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4. 本说明书如有版本变更不另外告知。

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2. We strongly recommend customers check carefully on the trademark when buying our product, if there is any question, please don't be hesitate to contact us.
3. Please do not exceed the absolute maximum ratings of the device when circuit designing.
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